

### Description

The FDMS6673BZ uses advanced trench technology

to provide excellent  $R_{\text{DS}(\text{ON})},$  low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

### **General Features**

V<sub>DS</sub> = -30VI <sub>D</sub> =-70A

 $R_{DS(ON)} < 8.8 m_{\Omega} V_{GS}$ =-10V

### Application

Battery protection

Load switch

Uninterruptible power supply

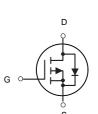
### Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
FDMS6673BZ	DFN5X6-8L	HXY MOSFET	5000

#### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

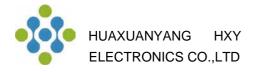
Symbol	Parameter	ter Rating	
Vds	Drain-Source Voltage	-30	V
Vgs	Gate-Source Voltage	±20	V
l₀@Tc=25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-70	A
l₀@Tc=75°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	-40	А
Ідм	Pulsed Drain Current <sup>2</sup>	-175	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	31	mJ
P <b></b> @Tc=25°C	Total Power Dissipation <sup>4</sup>	31.2	W
Тѕтд	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rejc	Thermal Resistance Junction-Case <sup>1</sup>	4	°C/W
Reja	Thermal Resistance Junction-Ambient <sup>1</sup>	61	°C/W





DFN5X6-8L

P-Channel MOSFET



### ElectricalCharacteristics(T J=25℃ unless otherwise noted)

Parameter		Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Drain-Source Breakdown Voltage		V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250µA	-30	-	-	V	
Gate-body Leakage current		lgss	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	±100	nA	
Zero Gate Voltage Drain Current	TJ=25℃	- I <sub>DSS</sub>	$V_{DS} = -24V, V_{GS} = 0V$	-	-	-1	μA	
	TJ=55℃	IDSS	$v_{\rm DS} = -24v, v_{\rm GS} = 0v$	-	-	-5		
Gate-Threshold Voltage			$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1.0	-1.6	-2.5	V	
Drain-Source On-Resistance <sup>2</sup>		B	V <sub>GS</sub> = -10V, I <sub>D</sub> = -12A	-	6	8.8		
		R <sub>DS(on)</sub>	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -8A	-	9	14	mΩ	
Forward Transconductance		<b>g</b> fs	V <sub>DS</sub> = -5V, I <sub>D</sub> = -20A	-	28	-	S	
Input Capacitance		C <sub>iss</sub>		-	4320	-	pF	
Output Capacitance		Coss	V <sub>DS</sub> = -15V, V <sub>GS</sub> =0V, f =1MHz	-	529	-		
Reverse Transfer Capacitance		Crss		-	487	-		
Gate Resistance		Rg	$V_{DS}$ = 0V, $V_{GS}$ = 0V, f=1.0MHz	-	4.0	-	Ω	
Total Gate Charge		Qg		-	45	-		
Gate-Source Charge		Q <sub>gs</sub>	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -15V, I <sub>D</sub> = -15A	-	8.5	-	nC	
Gate-Drain Charge		Q <sub>gd</sub>		-	12.8	-		
Turn-On Delay Time		td(on)		-	18.9	-	nS	
Rise Time		tr	$V_{GS}$ = -10V, $V_{DD}$ = -15V, R <sub>G</sub> = 2.5Ω, I <sub>D</sub> = -15A	-	15.7	-		
Turn-Off Delay Time		t <sub>d(off)</sub>		-	64.8	-		
Fall Time		t <sub>f</sub>		-	36.5	-		
Diode Forward Voltage <sup>2</sup>		Vsd	I <sub>S</sub> = -1A, V <sub>GS</sub> = 0V	-	-	-1	V	
Continuous Source Current <sup>1,5</sup>		ls	Vg=VD=0V , Force Current	-	-	-70	А	

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

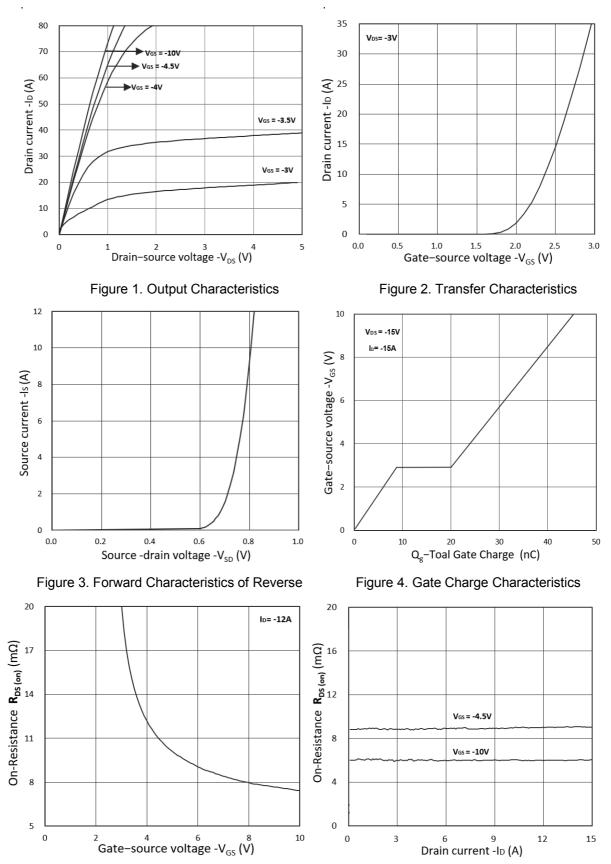
2.The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

3. The EAS data shows Max. rating . The test condition is V\_DD= -25V, V\_GS= -10V, L= 0.1mH, I\_{AS}= -25A

4.The power dissipation is limited by 150°C junction temperature

5. The data is theoretically the same as  $I_D$  and  $I_{DM}$ , in real applications, should be limited by total power dissipation.

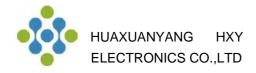


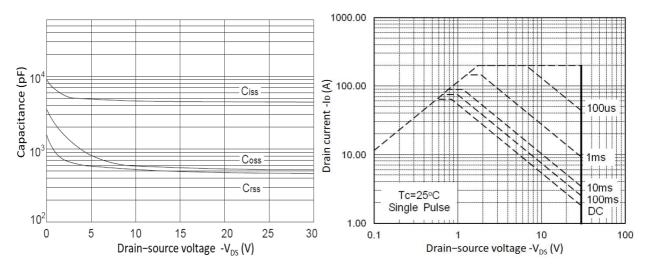


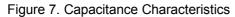
### **Typical Electrical And Thermal Characteristics (Curves)**



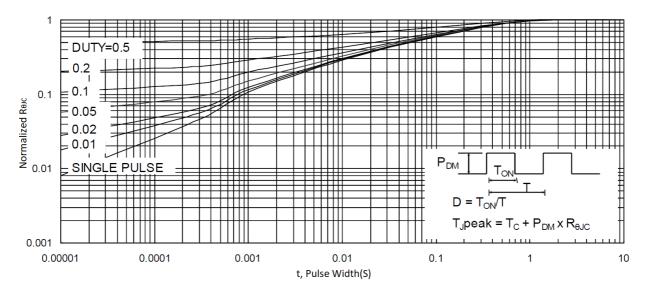
Figure 6. RDS(on) vs. ID













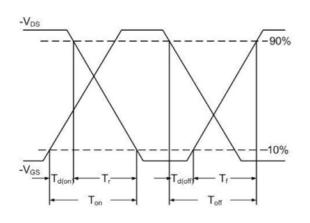
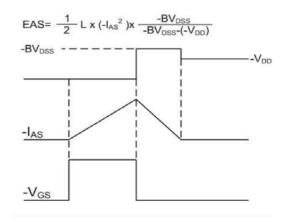
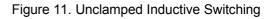


Figure 10. Switching Time Waveform

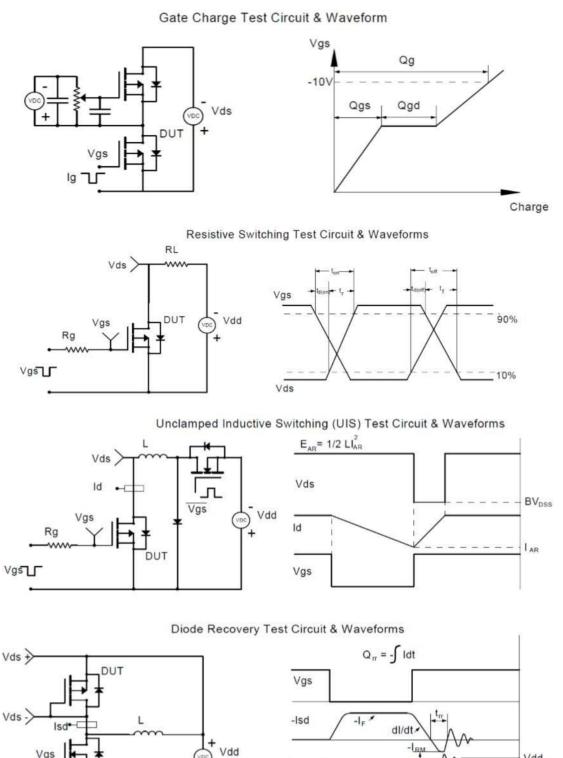




Waveform



## **Test Circuit**



-Vds

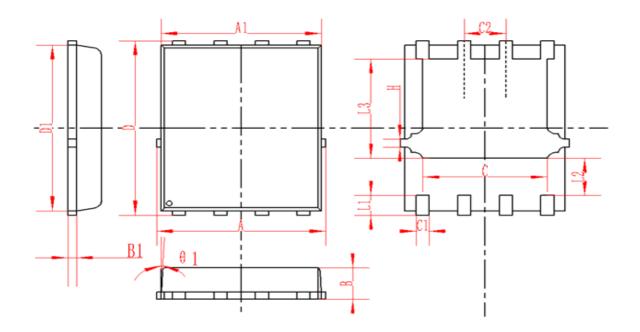
Vgs

lg \_\_\_\_

Vdd



### DFN5X6-8L Package Information



SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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